



1

Product Change Notification

110233 - 00

Information in this document is provided in connection with Intel products. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Intel's Terms and Conditions of Sale for such products, Intel assumes no liability whatsoever, and Intel disclaims any express or implied warranty, relating to sale and/or use of Intel products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Intel products are not intended for use in medical, life saving, or life sustaining applications. Intel may make changes to specifications and product descriptions at any time, without notice.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

Copyright © Intel Corporation 2010. Other names and brands may be claimed as the property of others.

Celeron, Centrino, Intel, the Intel logo, Intel Core, Intel NetBurst, Intel NetMerge, Intel NetStructure, Intel SingleDriver, Intel SpeedStep, Intel StrataFlash, Intel Viiv, Intel XScale, Itanium, MMX, Paragon, PDCharm, Pentium, and Xeon are trademarks or registered trademarks of Intel Corporation or its subsidiaries in the United States and other countries.

Learn how to use Intel Trade Marks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.



Product Change Notification

Change Notification #: 110233 - 00
Change Title: AXX6DRV3GR, AXX6DRV3GEXP,
AXX4DRV3GR and AXX4DRV3GEXP, PCN
110233-00, Product Material, Product
package change
Date of Publication: September 20, 2010

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Oct 29, 2010
---	--------------

Description of Change to the Customer:

Intel will change the package of below 4 hard disk cage kit accessories for Intel(R) Server chassis SC5299/SC5400 and SC5650/SC5600 families:

AXX6DRV3GR;
AXX6DRV3GEXP;
AXX4DRV3GR;
AXX4DRV3GEXP

The backplane board on the kit will be separately packaged in order to better protect the electrical components on the backplane board. Please refer to the following 2 pictures for the details:

Before the change:



Backplane board is pre-assembled in the kit package

After the change:



Backplane board will now be separately packaged

Please refer to the installation guide in the package for detailed instructions on how to assemble/remove the backplane board from the hard disk cage kit.

Customer Impact of Change and Recommended Action:

Intel does not foresee any adverse customer impact from these changes. Intel recommends that the customer check the new installation guide when the updated products become available.

Products Affected / Intel Ordering Codes:

Pre Change Product Code	Pre Change MM#	Pre Change TA	Post Change Product Code	Post Change MM#	Post Change TA
AXX4DRV3GR	900404	E57791-001	AXX4DRV3GR	900404	E57791-002
AXX6DRV3GR	900405	E57792-001	AXX6DRV3GR	900405	E57792-002
AXX4DRV3GEXP	877236	D30692-005	AXX4DRV3GEXP	877236	D30692-006
AXX6DRV3GEXP	877235	D30691-006	AXX6DRV3GEXP	877235	D30691-007

Reference Documents / Attachments:

Document:

Location #:

PCN Revision History:

Date of Revision:

September 20, 2010

Revision Number:

00

Reason:

Originally Published PCN